

Low Pass Filter

Mini-Circuits

50Ω DC to 6GHz

KEY FEATURES

- Low Passband Insertion Loss of 0.7dB Typ.
- High Rejection of 38dB Typ.
- Good Return Loss of 16dB Typ.
- Small Size, 5.59 x 8.13 x 2.03 mm

APPLICATIONS

- Harmonic Rejection
- VHF/UHF Transmitters/Receivers.
- Test and Measurement Equipment.

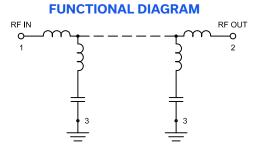


ALF-6000+

Generic photo used for illustration purposes only

PRODUCT OVERVIEW

Mini-Circuits' Surface Mount Thin-Film filters offer low insertion loss and high rejection realized via Thin-Film on Alumina substrate, using a sputtering process that can guarantee an enhanced Q and repeatable performance. Low pass, high pass, and bandpass surface mount thin-film designs can be realized with this technology up to 40GHz in a small form factor helping customers achieve their SWaP objectives. Using our high quality thin-film manufacturing process we can guarantee repeatability on large batches of filters.



ELECTRICAL SPECIFICATIONS^{1,2} AT +25°C

Parameter		F#	Frequency (GHz)	Min.	Тур.	Max.	Units
Pass Band	Insertion Loss	DC-F1	DC - 6	_	0.7	1.2	dB
	Freq. Cut-Off ³	Fc	6.93	_	3.0	_	dB
	Return Loss	DC-F1	DC - 6	_	16	_	dB
	Rejection	F2-F3	8.2 - 9.4	25	37	_	
Stop Band		F3-F4	9.4 - 13	32	37	_	ID
		F4-F5	13 - 14	_	38	_	dB
		F5-F6	14 - 15.5	—	15	_	

1. Tested in Evaluation Board P/N TB-ALF-6000+ with feedline losses removed by normalization of S12 and S21 traces to mesurement of TB thru-line.

2. This filter is bi-directional RF1 and RF2 ports may be interchanged, see S-Parameters for actual performance.

3. Typical variation ±3%

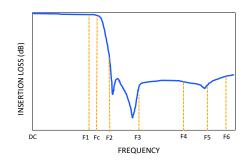
ABSOLUTE MAXIMUM RATINGS⁴

Parameter	Ratings	
Operating Temperature	-55 °C to +125 °C	
Storage Temperature	-55 °C to +125 °C	
Input Power ⁵	15 Max. at 25°C	

4. Permanent damage may occur if any of these limits are exceeded.

5. Power rating applies only to signals within the passband.

TYPICAL FREQUENCY RESPONSE





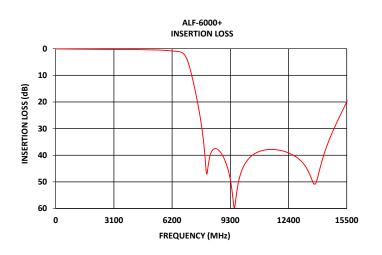


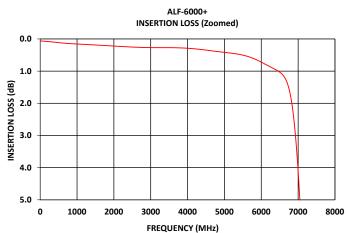


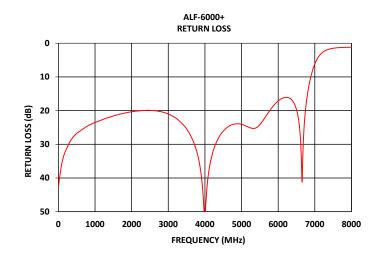
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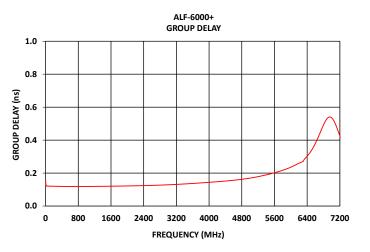
DC to 6GHz

TYPICAL PERFORMANCE GRAPHS AT +25°C









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THIN FILM SURFACE MOUNT

_ow Pass Filter



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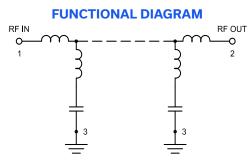


Figure 1. ALF-6000+ Functional Diagram

PAD DESCRIPTION

Function	Pad Number	Description
RF1 ²	1	Connects to RF Input Port
RF2 ²	2	Connects to RF Output Port
GROUND	3	Connects to Ground on PCB, (See drawing PL-764)
NC –		No connection, not used internally. See drawing PL-764 for connection to PCB

SUGGESTED PCB LAYOUT (PL-764)

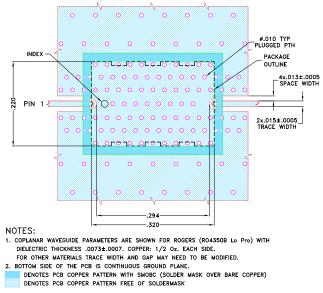


Figure 2. Suggested PCB Layout PL-764

TOP VIEW PCB LAND PATTERN .220 [5.59] Ø.014 [Ø0.36] .220 INDEX -.320 [8.13]-080 [2 03 -R.013 (R0.33) 320 [8,13]-Ъ, Я SUGGESTED LAYOUT TOLERANCE TO BE WITHIN: ±.002 -.007 [0.18] - 013 [0.33] 110 2 701 026 [0.65] WEIGHT: 0.2 grams DIMENSIONS ARE IN INCHS [MM]. TOLERANCES: 2 PL.±.01; 3 PL.±.005 .014 [0.36] METALLIZATION BOTTOM VIEW

CASE STYLE DRAWING

PRODUCT MARKING*: ALF-6000

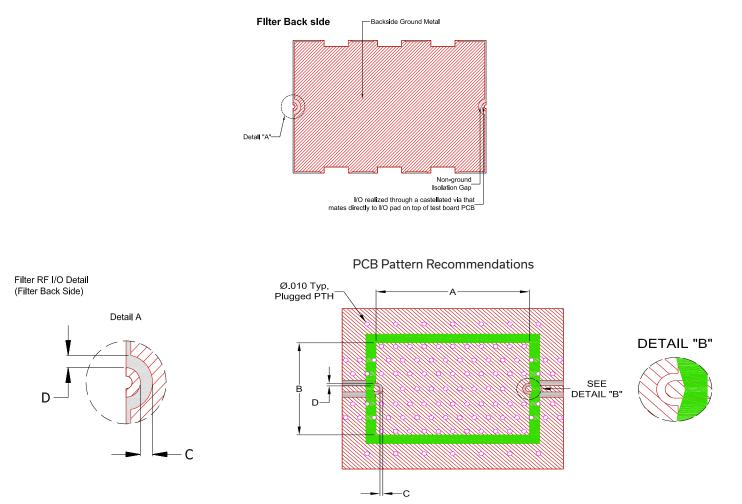
*Marking may contain other features or characters for internal lot control.



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RECOMMENDED PCB LAYOUT PATTERN FOR FILTER



- 1) Customer PCB's ground pattern length (dimension A) can be similar to filter length.
- 2) Customer PCB's ground pattern width (dimension B) can be similar filter width.
- 3) Dimensions C and D on Filter RF I/O detail and Customer PCB pattern can be closely match. The dimensions of C and D on the Customer PCB pattern can be slightly larger to account for component alignment tolerance (ground metal can be pulled back from RF I/O trace).
- 4) Recommend to use Solder mask at Customer PCB at outer area of filter pattern/ footprint with a clearance of about 1.25mil at each side. (Tighter registration tolerance required for solder mask)
- 5) Recommended to use Solder mask at I/O of Customer PCB as per above diagram (refer detail B).

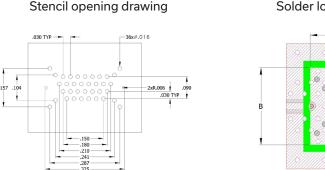




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COMMENTS ON COMPONENT HANDLING AND SOLDER ATTACH

- 1) Avoid using soldering iron directly to the ceramic filter. This would lead to development of crack in the component due to thermal shock.
- 2) Vacuum pick-up tool or plastic tweezers are recommended for handling the components. Extra care should be taken not to scratch the filter or metal area.
- 3) Use 2-3 mil thickness stencil plate and screen print the solder. Refer below picture for recommended stencil pattern to get the best solder attachment.



Solder location after screen print



- 4) Plugged ground vias in the PWB will improve attachment consistency.
- 5) Recommended to have a similar or closer test board material and thickness (refer Mini-Circuits evaluation board for details) to minimize the CTE over the temperature range.



THIN FILM SURFACE MOUNT

Low Pass Filter



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ADDITIONAL DETAILED INFORMATION IS AVAILABLE ON OUR DASH BOARD.

CLICK HERE

	Data		
Performance Data and Graphs	Graphs		
	S-Parameter (S2P Files) Data Set (.zip file) De-embedded to device pads		
Case Style	UC2731 Lead Finish: Gold over Nickel Plate.		
RoHS Status	Compliant		
Tape and Reel	TR-F003		
Suggested Layout for PCB Design	PL-764		
Evaluation Board	TB-ALF-6000+		
	Gerber File		
Environmental Rating	ENV120		

NOTES

A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.

B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuits' applicable established test performance criteria and measurement instructions.

C. The parts covered by this specification document are subject to Mini-Circuits' standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html

